FEATURES

- Quasi-Resonant for High Efficiency
- Support Single Windings Design
- Built-in HV MOSFET and Power Supply Circuit
- Low Cost Boost APFC Solution
- PF>0.9 and THD<10% with Universal Input
- Fast Startup < 200ms
- High Precision CV Regulation
- Very Low VDD Operation Current
- Excellent Line and Load Regulation
- Built-in Protections:
 - Output Over Voltage Protection (OVP)
 - Output Under Voltage Protection (UVP)
 - Cycle-by-Cycle Current Limiting (OCP)
 - Leading Edge Blanking (LEB)
 - On-Chip Thermal Fold back (OTP)
- Available in SOP-8 Package

GENERAL DESCRIPTION

FC1511 is a highly integrated Boost PFC Constant Voltage Controller. The IC utilizes Quasi-Resonant (QR) Boost topology with active PFC control for high PF, low THD, and high efficiency.

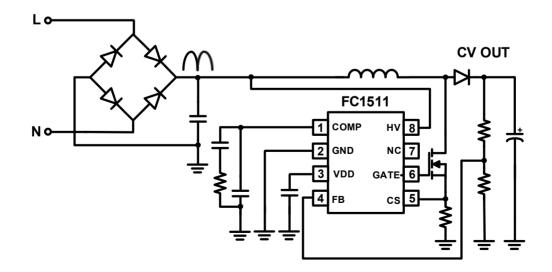
FC1511 integrates with demagnetization signal detection technology, 650V high voltage startup and IC power supply circuit, which eliminates auxiliary windings for demagnetization detection and power supply, simplifies system design and lower cost.

FC1511 integrates functions and protections of Under Voltage Lockout (UVLO), Cycle-by-cycle Current Limiting (OCP), Thermal Foldback (OTP), Output Over Voltage Protection (OVP), Output Under Voltage Protection (UVP) etc.

APPLICATIONS

High Power PFC Application

TYPICAL APPLICATION CIRCUIT





High Efficiency QR Boost PFC Constant Voltage Controller

Pin Configuration



SOP-8

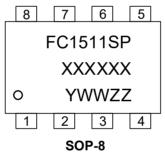
Marking Information

XXXXXX: Wafer Lot Code

Y: Year Code

WW : Week Code, 01-52

ZZ : Serial Number, 01-99 or A0-ZZ



Pin Description

Pin Number	Pin Name	I/O	Description	
1	COMP	I/O	Loop Compensation Pin	
2	GND	Р	IC Ground Pin	
3	VDD	Р	IC Power Supply Pin. Connect a >2.2µF capacitor between this pin and GND	
4	FB	ı	Output Voltage Setting Pin, Steady State Setting at 2.4V	
5	CS	I	Current Sense Input Pin	
6	GATE	0	Gate Driver Output Pin, Connected to the gate of MOSFET	
7	NC		No Function Pin, Left Floating in use	
8	HV	Р	Internal High Voltage Startup and Power Supply Input	

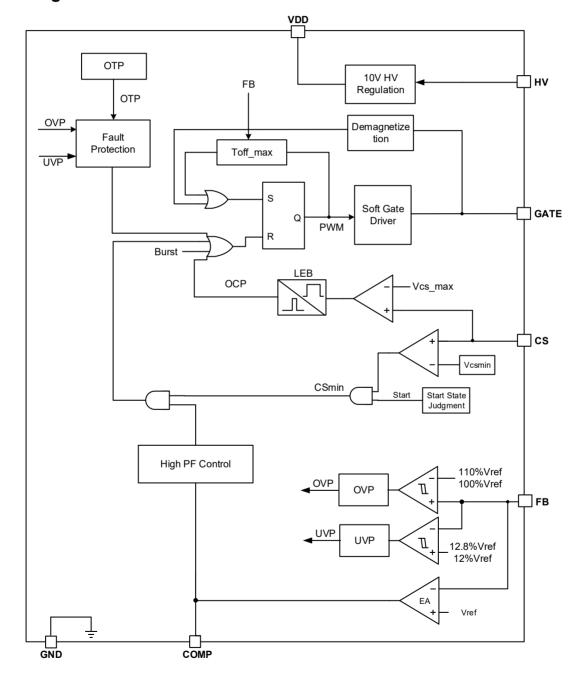


Ordering Information

Part Number	Description	
FC1511SPA	SOP-8, Pb free in T&R, 4000 Pcs/Reel	

Note: Suffix "A" - Tape & Reel.

Block Diagram





High Efficiency QR Boost PFC Constant Voltage Controller

Absolute Maximum Ratings (Note 1)

Parameter	Value	Unit
HV Pin Voltage Range	-0.3 to 650	V
VDD DC Supply Voltage	Self-Limited	V
VDD DC Clamp Current	10	mA
CS, FB, COMPVoltage Range	-0.3 to 7	V
P _{Dmax} , Power dissipation @T _A =50 ℃ (SOP-8), (Note 2)	0.6	W
θ _{JA} , Thermal ResistanceJunction to Ambient (SOP-8), (Note 2)	165	°C/W
Maximum Junction Temperature	150	°C
Storage Temperature Range	-65 to 150	°C
Lead Temperature (Soldering, 10sec.)	260	°C
ESD Capability, HBM (Human Body Model)	3	kV

Recommended Operation Conditions

Parameter	Value	Unit
Operating Junction Temperature	-40 to 125	೦

Electrical Characteristics (Ta = 25 °C, VDD=10V, if not otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit		
Supply Volt	Supply Voltage Section (VDD Pin)							
I _{VDD_st}	VDD pin Start-up Current	VDD <v<sub>DD_Op</v<sub>		300	700	μΑ		
I _{VDD_Op}	Operation Current	Fsw=7kHz	80	200	350	μA		
V_{DD_Op}	VDD Operation Voltage		9	10	12.5	V		
V_{DD_OFF}	VDD Under Voltage Lockout Enter		6.5	7.5	8.5	V		
V_{DD_Clamp}	VDD Clamp Voltage	$I(V_{DD}) = 5 \text{ mA}$	13	14.1	15.5	V		
Driver Secti	on		•					
T _{dem_blank}	Turn Off Blanking Time	(Note 3)		2.5		μs		
T _{on_max}	Maximum ON Time		20	30	50	μs		
T _{off_max_st}	Maximum OFF Time at Startup		105	150	195	μs		
T _{off_max}	Maximum OFF Time at Steady State		195	270	350	μs		
F _{max}	Max. Switching Frequency			200		kHz		





Current Sen	se Input Section (CS Pin)					
V _{cs_max}	Current Limiting Threshold		1.8	2	2.2	V
T_{D_OC}	Over Current Detection and Control Delay			100		ns
$V_{cs_min_st}$	Minimum Current Sensing Limit at Startup		0.6	0.67	0.73	V
$V_{\text{cs_min}}$	Minimum Current Sensing Limit at Steady State		90	100	110	mV
Output Prot	ection Section (FB PIN)					
V_{ref}	Reference Voltage		2.37	2.4	2.47	V
V _{FB_OVP_EN}	Enter OVP Voltage	110% Ref	2.62	2.68	2.75	V
V _{FB_OVP_EX}	Exit OVP Voltage	100% Ref	2.37	2.4	2.47	V
$V_{FB_OVP_Deb}$	Debounce Time			10		μs
V _{FB_UVP_EN}	Enter UVP Voltage	12% Ref	0.2	0.3	0.4	V
V _{FB_UVP_EX}	Exit UVP Voltage	12.8% Ref		0.32		V
V _{FB_UVP_Deb}	Debounce Time			10		μs
Gate Driver	Section (GATE Pin)		<u> </u>			
I _{source}	Maximum Source Current	VDRV=0V		70		mA
Isink	Maximum Sink Current	VDRV=12V		100		mA
CV Loop Co	empensation Section (COMP P	in)	·			
V _{comp_H}	COMP High Clamp Voltage			4.5		V
V _{comp_L}	COMP Low Clamp Voltage			1.2		V
Over Tempe	erature Protection		<u> </u>			
T _{OTP_EN}	Thermal Foldback Trigger Point	(Note 3)		150		$^{\circ}$
T_{OTP_EX}	OTP Recovery Threshold			140		°C
HV Startup	and IC Supply Section (HV Pin)				
V_{BR}	HVDD Pin Breakdown Voltage		650			V
I_{HV}	HV Charging Current	HV=20V		10		mA
I _{HV_leak}	Leakage Current of HV Charging Circuit		10	40	60	μA

Note 1. Stresses listed as the above "Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to maximum rating conditions for extended periods may remain possibility to affect device reliability.

Note 2. Maximum Power dissipation P_{Dmax} = $(T_{Jmax}$ - $T_A)/\theta_{JA}$. As ambient temperature rises, P_{Dmax} will decrease.

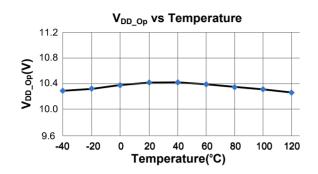
Note 3. Guaranteed by the Design.

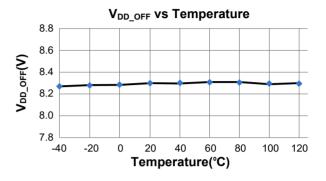
Revision No: 0

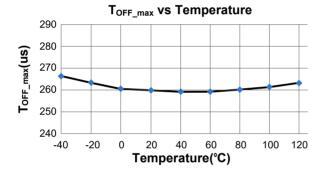


High Efficiency QR Boost PFC Constant Voltage Controller

Characterization Plots









High Efficiency QR Boost PFC Constant Voltage Controller

Operation Description

FC1511 is a highly integrated Boost PFC Constant Voltage Controller. The IC utilizes Quasi-Resonant (QR) Boost topology with active PFC control for high PF, low THD, and high efficiency.

10V Regulator

In FC1511, the 10V regulator charges VDD hold-up capacitor to 10V by drawing a current from the voltage on the HV pin. Extremely low IC power consumption allows FC1511 to operate continuously from the current drawn from the HV pin. A capacitor value about $2.2\mu F$ at least is sufficient for both high frequency decoupling and energy storage.

System Start-Up Operation

After system power up, VDD hold up capacitor is charged by the internal HV startup circuit through HV pin. When VDD pin voltage reaches the turn on threshold, the IC begins working. The COMP pin is pulled up to 1.2V quickly, then the IC begins to work at low switching frequency, the COMP pin voltage rises up gradually, thus the inductor peak current also rises up. The output voltage achieves a soft start without over shoot.

Constant Voltage (CV) Control

The FC1511 samples the output voltage through the FB pin and compares it with the internal highprecision 2.4V reference to maintain a constant output voltage. The output voltage under closed loop control is determined by the following formula:

$$V_{o}(V) = \frac{V_{ref}}{R_{ref}} X(R_{rB1} + R_{rB2})$$

In the equation above,

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R_{FB1}---the Resistor between FB pin and GND

R_{FB2}--- the Upper Voltage Divider Resistor

Leading Edge Blanking (LEB)

Each time the power MOSFET is switched on, a turn-on spike occurs across the sensing resistor. The spike is caused by the MOSFET parasitic capacitance and freewheeling diode reverse recovery current. To avoid premature termination of the switching pulse, an internal leading edge blanking circuit is built in. During this blanking period (300ns, typical), the PWM comparator is disabled and cannot switch off the gate driver.

Cycle-by-cycle Current Limit Protection (OCP)

The FC1511 limits the maximum inductor current through the MOSFET each time the power MOSFET is turned on. When the CS voltage exceeds the peak current reference Vcs_max, the power MOSFET is immediately turned off.

Demagnetization Detection

FC1511 integrates demagnetization module which eliminates auxiliary windings to detect demagnetization signals for quasi-resonance control and lower cost.

Time Control

In FC1511, a blank time (typically $1\mu s$) is implemented to suppress ringing when the power MOSFET is off to avoid OVP false triggering. The maximum OFF time in FC1511 is typically 270 μs . FC1511 also integrates duty cycle clamping function. The maximum operation frequency is limited to less than 200 kHz.

Output Over Voltage Protection (OVP)

The output voltage can be detected by the FB pin. When the FB voltage is higher than FB High Voltage Threshold voltage (VFB_H), the power MOSFET stops switching immediately. The output

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High Efficiency QR Boost PFC Constant Voltage Controller

over voltage is determined by:

$$V_{OVP}(V) = \frac{V_{FB_H}}{R_{FB1}} \times (R_{FB1} + R_{FB2})$$

where:

R_{FB1}---the Resistor between FB pin and GND

R_{FB2}--- the Upper Voltage Divider Resistor

Light Load Mode

When the FC1511 detects a light load, the system enters Burst mode to improve efficiency of light load and reduce system standby loss.

On Chip Thermal Foldback (OTP)

FC1511 integrates thermal foldback function. When the IC temperature is over $150\,^{\circ}$ C, the IC stops switching. When the IC temperature is under $140\,^{\circ}$ C, the system restart. In this way, the system temperature is limited and system reliability is also improved.

Soft Totem-Pole Gate Driver

FC1511 has a soft totem-pole gate driver with optimized EMI performance.

Application Information

PCB Layout Guidelines

PCB layout is very important for reliable operation. Please follow guideline to optimize performance.

- The area of main power switching loop should be as small as possible to reduce the EMI radiation, such as the inductor charging loop consisted by the EMI filter capacitor, inductor and IC; the inductor discharging loop consisted by the inductor, freewheeling diode and output capacitor.
- 2. Place the VDD Cap, COMP Cap, FB Res as close as the IC as possible.
- The power ground of the current sampling resistor is as thick as possible and should be as close as the IC GND as possible.

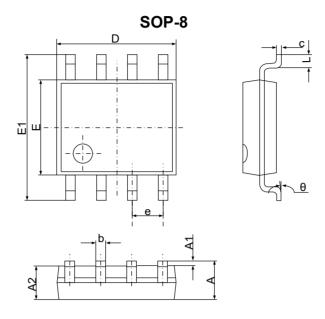




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High Efficiency QR Boost PFC Constant Voltage Controller

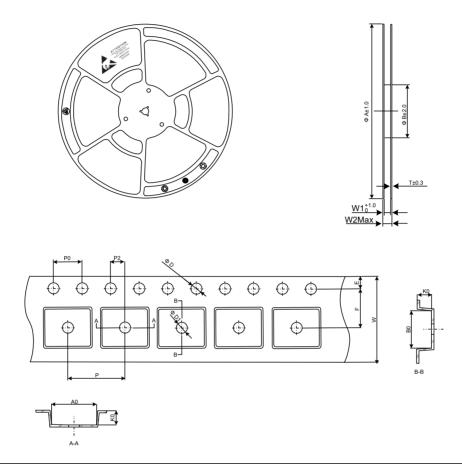
Package Dimension



Symbol	Dimensions I	Dimensions In Millimeters		s In Inches
	Min	Max	Min	Max
Α	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.300	1.500	0.051	0.059
b	0.330	0.510	0.013	0.020
С	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
е	1.270 (BSC)		0.050	(BSC)
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°



Tape and Reel Information



Reel Dimensions (mm)						
A B (Inner Diameter) W1 W2 Max T						
330	100	12.4	18.4	1.5		

Tape Dimensions						
Symbol	Dimensions (mm)	Symbol	Dimensions (mm)			
Е	1.75±0.10	W	12.00±0.10			
F	5.50±0.10	Р	8.00±0.10			
P2	2.00±0.10	A0	6.60±0.10			
D	$1.50^{+0.1}_{-0}$	В0	5.30±0.10			
D1	1.55±0.05	K0	1.90±0.10			
P0	4.00±0.10					

Packing Quantity					
Package Pcs/Reel Reels/Box Boxes/Carton Pcs/Carton					
SOP-8	4000	2	8	64000	